Power MOSFET

-30 V, -3.5 A, Single P-Channel, SOT-23

Features

- Low R_{DS(on)} at Low Gate Voltage
- Low Threshold Voltage
- High Power and Current Handling Capability
- This is a Pb–Free Device

Applications

- · Load Switch
- Optimized for Battery and Load Management Applications in Portable Equipment like Cell Phones, PDA's, Media Players, etc.

MAXIMUM RATINGS (T _J = 25° C unless otherwise noted)							
Parameter			Symbol	Value	Unit		
Drain-to-Source Voltage			V _{DSS}	-30	V		
Gate-to-Source Voltage	Gate-to-Source Voltage			±12	V		
Continuous Drain	Steady	$T_A = 25^{\circ}C$		-2.2			
Current (Note 1)	State	T _A = 85°C	I _D	-1.5	А		
	t≤5 s	$T_A = 25^{\circ}C$		-3.5			
Power Dissipation (Note 1)	Steady State	T 05%0	ſ	0.48	w		
	t ≤ 5 s	T _A = 25°C	P _D	1.25	vv		
Pulsed Drain Current	t _p =	10 μs	I _{DM}	-15.0	А		
Operating Junction and Storage Temperature			T _J , T _{stg}	–55 to 150	°C		
Source Current (Body Diode)			۱ _S	-1.0	А		
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			ΤL	260	°C		

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE RATINGS

Parameter	Symbol	Мах	Unit
Junction-to-Ambient - Steady State (Note 1)	$R_{\theta JA}$	260	°C/W
Junction-to-Ambient – t \leq 10 s (Note 1)	$R_{\theta JA}$	100	

1. Surface-mounted on FR4 board using 1 in sq pad size (Cu area = 1.127 in sq [2 oz] including traces)

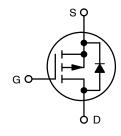


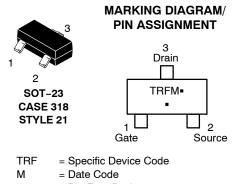
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V _{(BR)DSS}	R _{DS(on)} MAX	I _D MAX	
–30 V	75 mΩ @ −10 V	-2.2 A	
	110 mΩ @ –4.5 V	–1.8 A	
	150 mΩ @ –2.5 V	–1.0 A	

P-CHANNEL MOSFET





⁼ Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

Device	Package	Shipping [†]
NTR4171PT1G	SOT-23 (Pb-Free)	3000/Tape & Reel
NTR4171PT3G	SOT-23 (Pb-Free)	10000/Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

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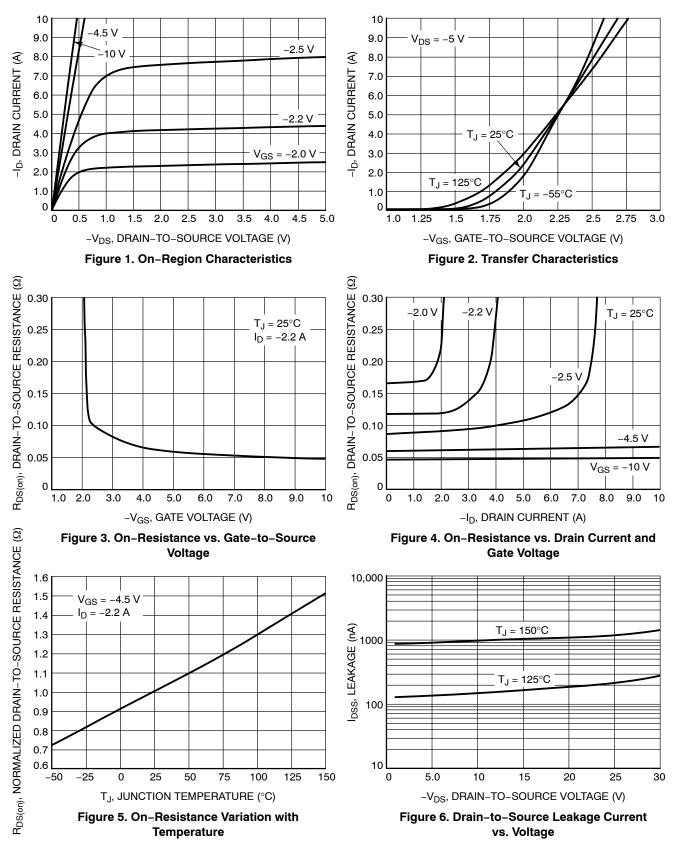
MOSFET ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise noted)

Parameter	Symbol	Test Condition	Min	Тур	Max	Units
OFF CHARACTERISTICS						
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I_D = -250 μ A	-30			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J	$I_D = -250 \ \mu A$, Reference to $25^{\circ}C$		24		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	$V_{GS} = 0 V, V_{DS} = -24 V, T_J = 25^{\circ}C$ $V_{GS} = 0 V, V_{DS} = -24 V, T_J = 85^{\circ}C$			-1.0 -5.0	μΑ
Gate-to-Source Leakage Current	I _{GSS}	V_{DS} = 0 V, V_{GS} = \pm 12 V			±0.1	μA
ON CHARACTERISTICS (Note 3)						
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}$, $I_D = -250 \ \mu A$	-0.7	-1.15	-1.4	V
Negative Threshold Temperature Coefficient	V _{GS(TH)} /T _J			3.5		mV/°C
Drain-to-Source On-Resistance	R _{DS(on)}	$V_{GS} = -10 \text{ V}, \text{ I}_{D} = -2.2 \text{ A}$		50	75	mΩ
		$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -1.8 \text{ A}$		60	110	
		V_{GS} = -2.5 V, I _D = -1.0 A		90	150	
Forward Transconductance	9 _{FS}	$V_{DS} = -5.0 \text{ V}, \text{ I}_{D} = -2.2 \text{ A}$		7.0		S
CHARGES, CAPACITANCES AND GATE R	ESISTANCE			•		
Input Capacitance	C _{iss}			720		pF
Output Capacitance	C _{oss}	V _{GS} = 0 V, f = 1.0 MHz, V _{DS} = -15 V		95		
Reverse Transfer Capacitance	C _{rss}	$v_{\rm DS} = -15$ v		65		
Total Gate Charge	Q _{G(TOT)}			15.6		nC
Threshold Gate Charge	Q _{G(TH)}	V _{GS} = –10 V, V _{DS} = –15 V,		0.7		
Gate-to-Source Charge	Q _{GS}	$I_{\rm D} = -3.5 \rm{A}$		1.6		
Gate-to-Drain Charge	Q _{GD}			2.6		
Total Gate Charge	Q _{G(TOT)}			7.4		nC
Threshold Gate Charge	Q _{G(TH)}	V _{GS} = -4.5 V, V _{DS} = -15 V,		0.7		
Gate-to-Source Charge	Q _{GS}	$I_{\rm D} = -3.5 \rm{A}$		1.6		
Gate-to-Drain Charge	Q _{GD}			2.6		
Gate Resistance	R _G			6.1		Ω
SWITCHING CHARACTERISTICS, V _{GS} = 4.	5 V (Note 4)					
Turn-On Delay Time	t _{d(on)}			8.0		ns
Rise Time	t _r	V _{GS} = –10 V, V _{DS} = –15 V,		11		1
Turn-Off Delay Time	t _{d(off)}	$I_D = -3.5 \text{ A}, R_G = 6 \Omega$		32		
Fall Time	t _f			14		1
Turn-On Delay Time	t _{d(on)}			9.0		ns
Rise Time	t _r			16		
Turn-Off Delay Time	t _{d(off)}	V_{GS} = –4.5 V, V_{DS} = –15 V, I_{D} = –3.5 A, R_{G} = 6 Ω		25		1
Fall Time	t _f			22		
DRAIN-SOURCE DIODE CHARACTERISTI						
Forward Diode Voltage	V _{SD}	V _{GS} = 0 V, I _S = -1.0 A, T _J = 25°C		-0.8	-1.2	V
Reverse Recovery Time	t _{RR}			14		ns
Charge Time	ta			10		1
Discharge Time	t _b	V_{GS} = 0 V, I _S = -1.0 A, dI _{SD} /d _t = 100 A/µs		4.0		1
Reverse Recovery Charge	Q _{RR}			8.0		nC

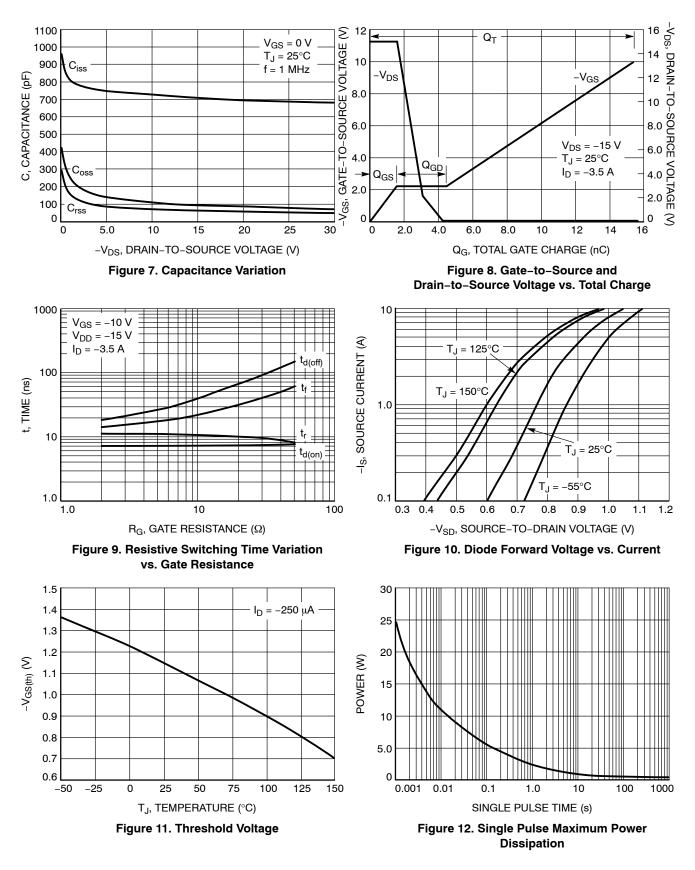
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.
2. Surface-mounted on FR4 board using 1 in sq pad size (Cu area = 1.127 in sq [2 oz] including traces)
3. Pulse Test: Pulse Width ≤ 300 µs, Duty Cycle ≤ 2%

4. Switching characteristics are independent of operating junction temperatures

TYPICAL CHARACTERISTICS

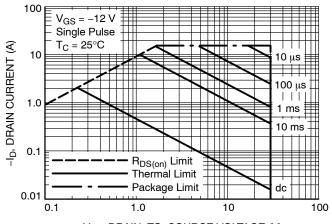


TYPICAL CHARACTERISTICS



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TYPICAL CHARACTERISTICS



-V_{DS}, DRAIN-TO-SOURCE VOLTAGE (V)

Figure 13. Maximum Rated Forward Biased Safe Operating Area

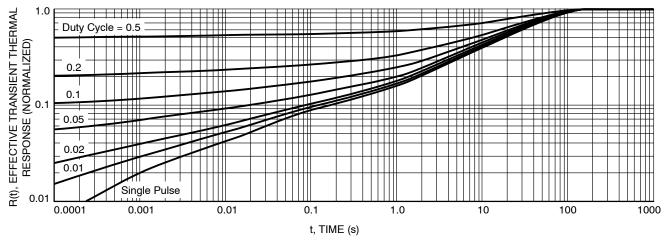
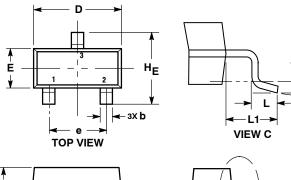


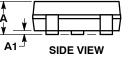
Figure 14. FET Thermal Response

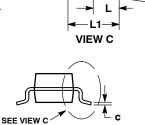
PACKAGE DIMENSIONS

SOT-23 (TO-236) CASE 318-08 **ISSUE AR**

0.25







END VIEW

NOTES:

- 1.
- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994. CONTROLLING DIMENSION: MILLIMETERS. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF з.
- THE BASE MATERIAL.
 DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.

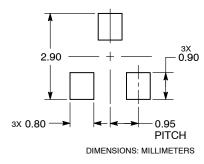
The medicine, on art benne.							
	MILLIMETERS			INCHES			
DIM	MIN	NOM	MAX	MIN	NOM	MAX	
Α	0.89	1.00	1.11	0.035	0.039	0.044	
A1	0.01	0.06	0.10	0.000	0.002	0.004	
b	0.37	0.44	0.50	0.015	0.017	0.020	
С	0.08	0.14	0.20	0.003	0.006	0.008	
D	2.80	2.90	3.04	0.110	0.114	0.120	
Е	1.20	1.30	1.40	0.047	0.051	0.055	
е	1.78	1.90	2.04	0.070	0.075	0.080	
L	0.30	0.43	0.55	0.012	0.017	0.022	
L1	0.35	0.54	0.69	0.014	0.021	0.027	
HE	2.10	2.40	2.64	0.083	0.094	0.104	
Т	0°		10 °	0 °		10 °	

STYLE 21: PIN 1. GATE

2. SOURCE

DRAIN 3

RECOMMENDED SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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